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1. Name of conveying party(ies):
 BioChip Technologies GmbH
 Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
 Name: Holger Klapproth
 Internal Address: Kehlerstrasse 12
79108 Freiburg, GERMANY
 Street Address: same as above
 City: _____ State: _____ Zip: _____
 Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
 Execution Date: December 18, 2003

4. Application number(s) or patent number(s):
 If this document is being filed together with a new application, the execution date of the application is: _____
 A. Patent Application No.(s) 10/343,024 B. Patent No.(s) _____
 Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
 Name: Joerg-Uwe Szipl, Esquire
 Internal Address: _____
 Street Address: 2300 Ninth Street, South
Suite PH-1
 City: Arlington State: VA Zip: 22204-2320

6. Total number of applications and patents involved: 1
 7. Total fee (37 CFR 3.41).....\$ 40.00
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9. Signature.
Joerg-Uwe Szipl, Reg. 31,799 [Signature] November 9, 2004
 Name of Person Signing Signature Date

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ÜBERTRAGUNGSERKLÄRUNG
DECLARATION OF ASSIGNMENT

European Patent No. 1 173 422
(Application No. 00 116342.7)
International Patent Application No. PCT/EP 01/09545 (=WO 2002010752 A2)
Australian Patent Application No. 200182017
Japanese Patent Application No. 2002/516625
US Patent Application No. 10/343,024

Titel:
Title: Sensor chips with multi-layers of polysiloxane

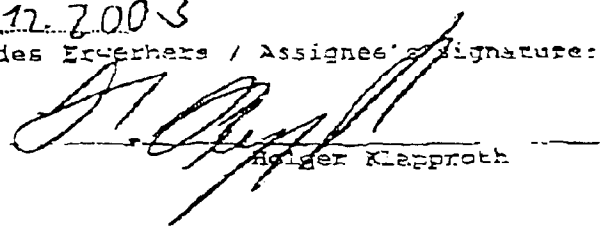
Wir, BioChip Technologies GmbH, Engesserstraße 4b, 79106 Freiburg, Deutschland, übertragen die oben genannten Patente / Patentanmeldungen und alle hierzu noch parallel existierenden Schutzrechte hiermit auf Herrn Holger Klapproth, Kehlerstraße 12, 79108 Freiburg, Deutschland, und sind mit der Umschreibung der obigen Schutzrechte auf Herrn Klapproth bei den jeweiligen Ämtern einverstanden. Das oben genannte Europäische Patent wird für alle Vertragsstaaten übertragen.

We, BioChip Technologies GmbH, Engesserstraße 4b, 79108 Freiburg, Germany, herewith assign the above-mentioned patents / patent applications and all corresponding patent / patent applications to Mr. Holger Klapproth, Kehlerstraße 12, 79106 Freiburg, Germany, and we agree to the recordal of the change of owner by the respective Patent Offices. The a.m. European Patent is assigned for all contracting states.

Freiburg, 18.12.2003
Unterschrift des Abtretenden / Assignor's Signature:
JÜRGEN METZGER
Rechtsanwalt
Untere Dorfstraße 8
Bio chip technologies GmbH
Jürgen Metzger 791030
Insolvenzverwalter / insolvency administrator

ANNAHMENERKLÄRUNG
DECLARATION OF ACCEPTANCE

Ich, Holger Klapproth, nehme die oben genannte Übertragungen an.
I, Holger Klapproth, accept the above assignments.

Freiburg, 12.12.2003
Unterschrift des Erwerbers / Assignee's Signature:

Holger Klapproth